# **MOSFET** – Power, Single, **N-Channel 40 V, 2.1 mΩ, 163 A**

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



# **ON Semiconductor®**

#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
40 V	2.1 mΩ @ 10 V	163 A

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	40	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain Cur-		$T_{C} = 25^{\circ}C$	۱ <sub>D</sub>	163	Α
rent $R_{\theta JC}$ (Notes 1 & 3)	Steady State	$T_{C} = 100^{\circ}C$		115	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	PD	117	W
		$T_{C} = 100^{\circ}C$		58	
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2 & 3)	Steady State	T <sub>A</sub> = 25°C	۱ <sub>D</sub>	26	А
		$T_A = 100^{\circ}C$		22	
Power Dissipation $R_{\theta JA}$		$T_A = 25^{\circ}C$	PD	3.2	W
(Notes 1 & 2)		$T_A = 100^{\circ}C$		2.2	
Pulsed Drain Current	$T_{A} = 25^{\circ}$	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	900	А
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to 175	°C
Source Current (Body Diode)			ا <sub>S</sub>	130	А
Single Pulse Drain-to-Source Avalanche Energy ( $T_J$ = 25°C, $I_{L(pk)}$ = 25 A)			E <sub>AS</sub>	420	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

\_\_\_\_\_

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

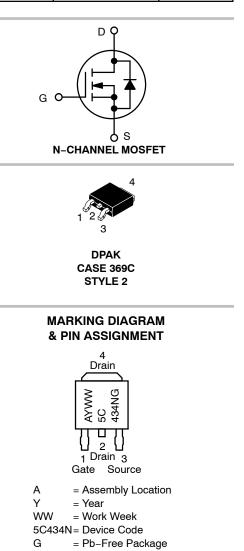
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	1.28	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	48	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.
Maximum current for pulses as long as 1 second is higher but is dependent

on pulse duration and duty cycle.



#### **ORDERING INFORMATION**

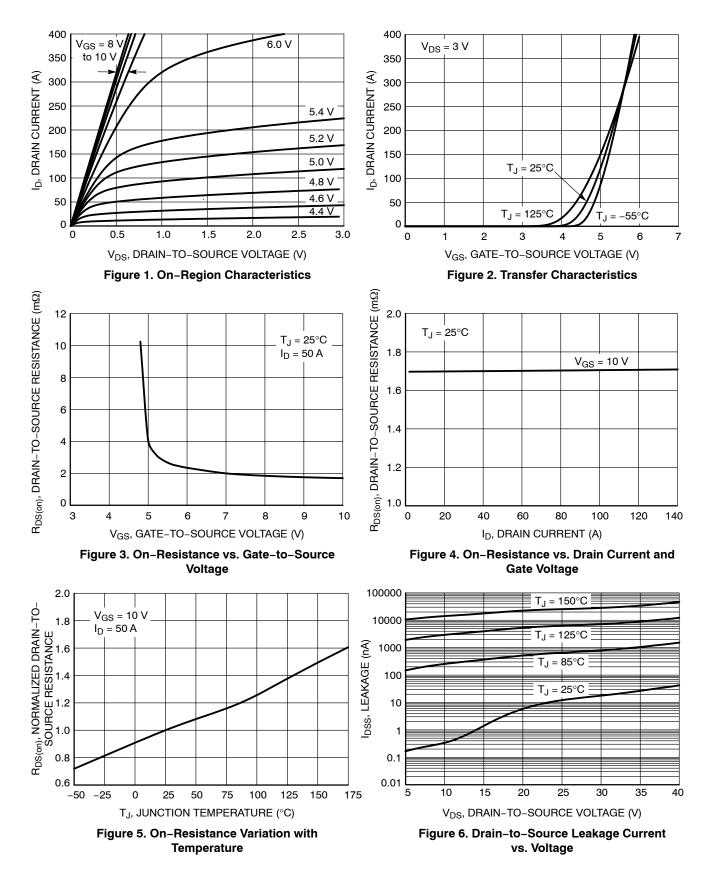
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise noted)

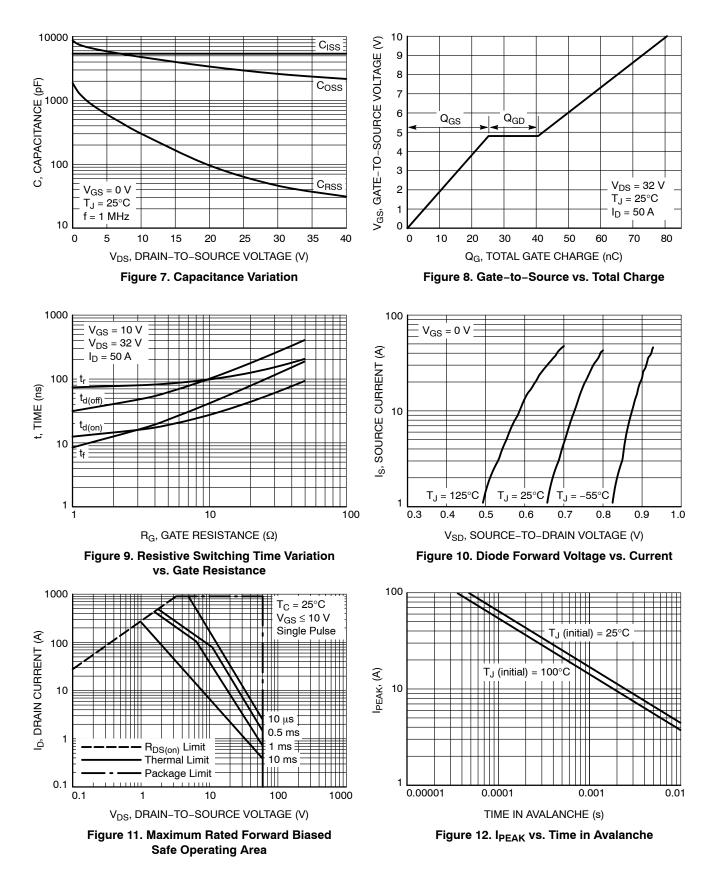
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				18		mV/°C
Zero Gate Voltage Drain Current	- 03,	$V_{GS} = 0 V_{,}$	$T_J = 25^{\circ}C$			10	μA
		$T_{\rm J} = 125^{\circ}C$			250		
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				7.9		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I	<sub>D</sub> = 50 A		1.7	2.1	mΩ
Forward Transconductance	<b>g</b> fs	$V_{DS} = 3 \text{ V}, \text{ I}_{D} = 50 \text{ A}$			155		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 25 V			5400		pF
Output Capacitance	C <sub>oss</sub>				3000		
Reverse Transfer Capacitance	C <sub>rss</sub>				71		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 32 V, I <sub>D</sub> = 50 A			80.6		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				15.2		
Gate-to-Source Charge	Q <sub>GS</sub>				25.2		
Gate-to-Drain Charge	Q <sub>GD</sub>				15.4		
Plateau Voltage	V <sub>GP</sub>				4.8		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 32 V, $I_{D}$ = 50 A, $R_{G}$ = 2.5 $\Omega$			15		ns
Rise Time	t <sub>r</sub>				78		1
Turn-Off Delay Time	t <sub>d(off)</sub>				43		
Fall Time	t <sub>f</sub>				14		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S				•	•	•
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 50 A	$T_J = 25^{\circ}C$		0.8	1.2	V
			T <sub>J</sub> = 125°C		0.7		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dls/dt = 100 A/μs, I <sub>S</sub> = 50 A			73		ns
Charge Time	ta				36		1
Discharge Time	tb				37		
Reverse Recovery Charge	Q <sub>RR</sub>				120		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%. 5. Switching characteristics are independent of operating junction temperatures. ditions, unless otherwise noted. Prod

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**

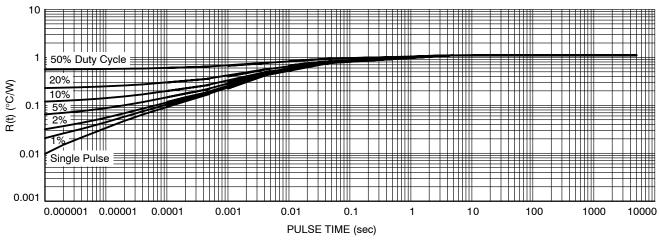


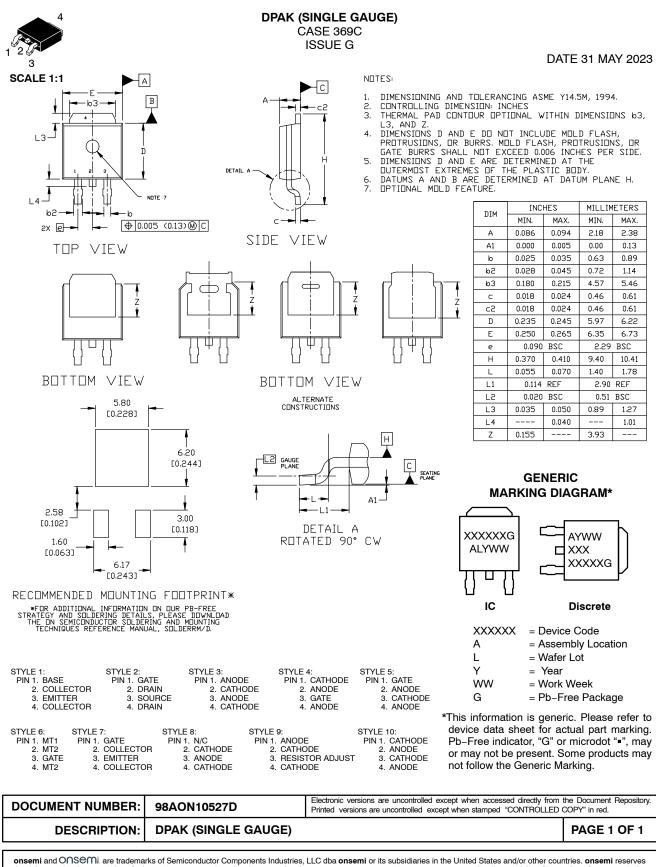
Figure 13. Thermal Characteristics

#### **ORDERING INFORMATION**

Order Number	Drder Number Package Shipping <sup>†</sup>		
NVD5C434NT4G	DPAK (Pb–Free)	2500 / Tape & Reel	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ONSEM**<sup>1</sup>.



onsemi and OTISETTIL are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>